



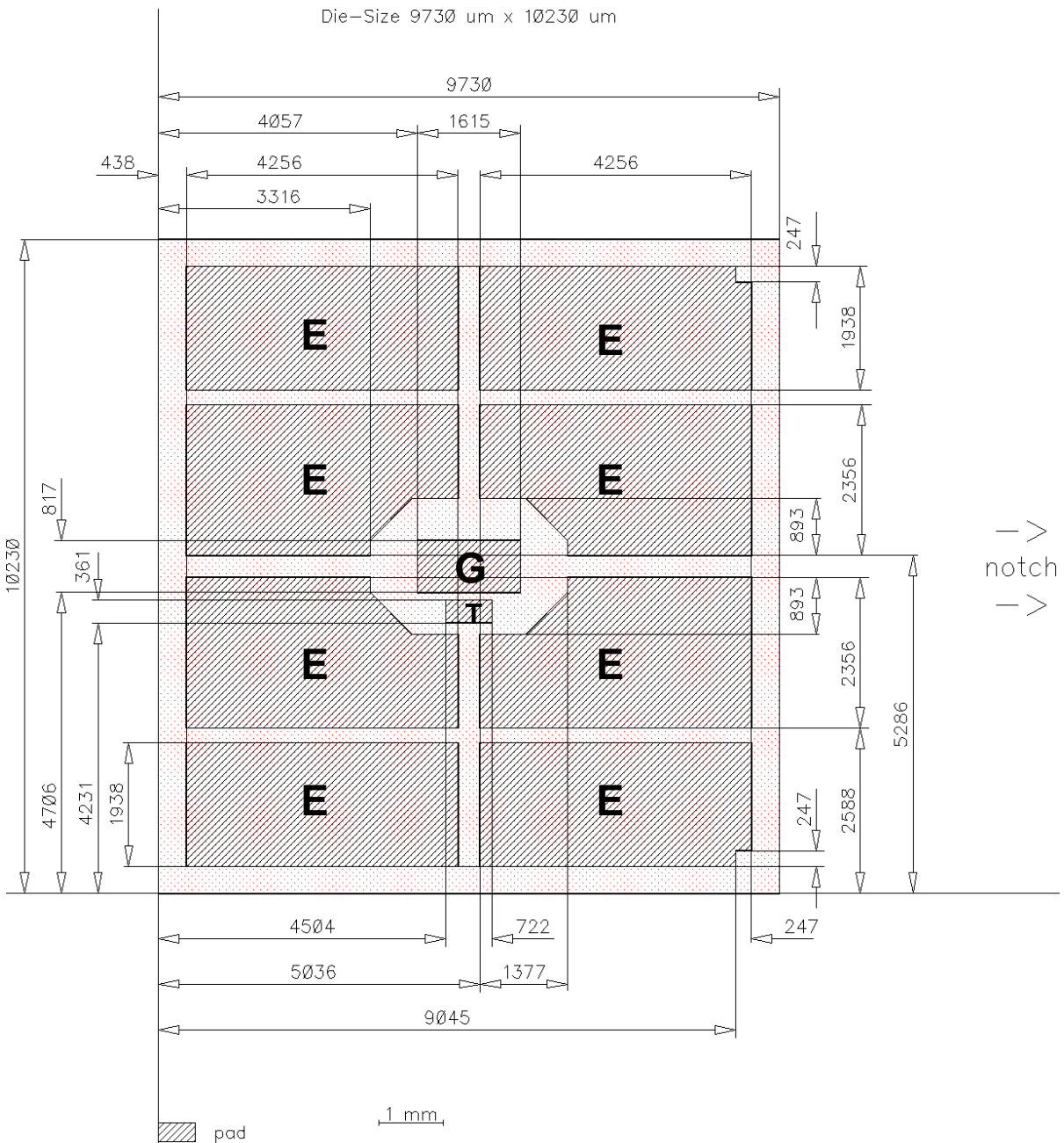
IGC100T65T8RM

Further Electrical Characteristic

Switching characteristics and thermal properties are depending strongly on module design and mounting technology and can therefore not be specified for a bare die.

This chip data sheet refers to the device data sheet	FS200R07N3E4R	Rev 2.0
--	---------------	---------

Chip Drawing



- E** = Emitter
- G** = Gate
- T** = Test pad do not contact